

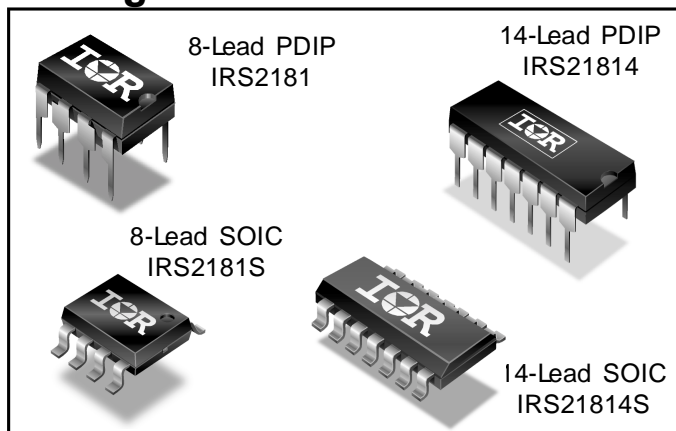
IRS2181/IRS21814(S)PbF

HIGH AND LOW SIDE DRIVER

Features

- Floating channel designed for bootstrap operation
- Fully operational to +600 V
- Tolerant to negative transient voltage, dV/dt immune
- Gate drive supply range from 10 V to 20 V
- Undervoltage lockout for both channels
- 3.3 V and 5 V input logic compatible
- Matched propagation delay for both channels
- Logic and power ground +/- 5 V offset
- Lower di/dt gate driver for better noise immunity
- Output source/sink current capability 1.4 A/1.8 A
- RoHS compliant

Packages



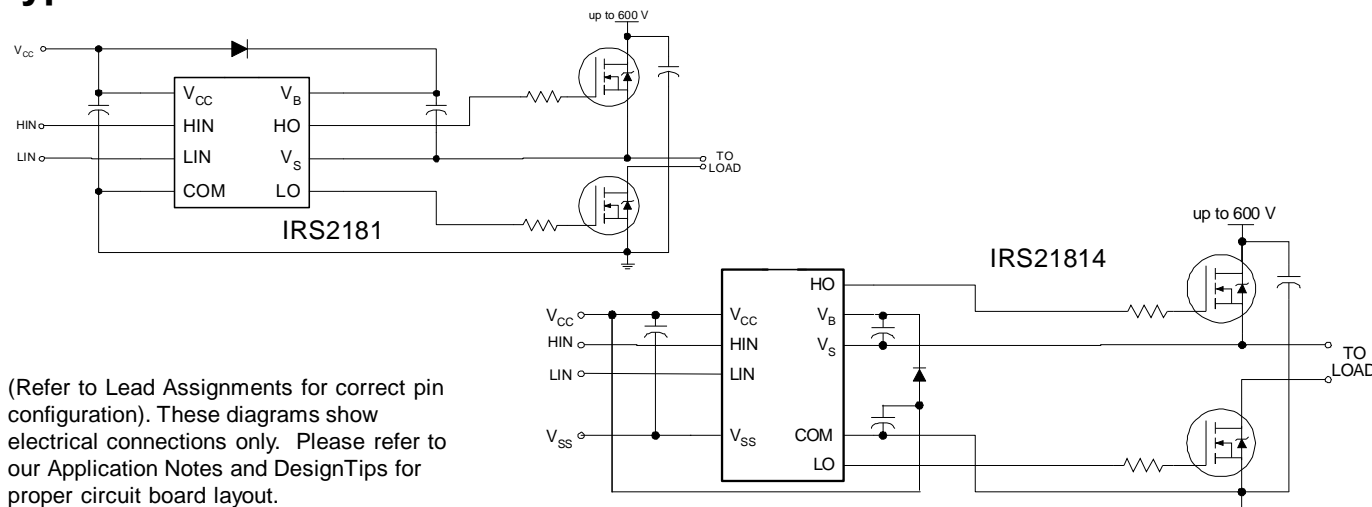
Description

The IRS2181/IRS21814 are high voltage, high speed power MOSFET and IGBT drivers with independent high-side and low-side referenced output channels. Proprietary HVIC and latch immune CMOS technologies enable ruggedized monolithic construction. The logic input is compatible with standard CMOS or LSTTL output, down to 3.3 V logic. The output drivers feature a high pulse current buffer stage designed for minimum driver cross-conduction. The floating channel can be used to drive an N-channel power MOSFET or IGBT in the high-side configuration which operates up to 600 V.

Feature Comparison

| Part | Input logic | Cross-conduction prevention logic | Deadtime (ns) | Ground Pins | t_{on}/t_{off} (ns) |
|-------|-------------|-----------------------------------|------------------|--------------|-----------------------|
| 2181 | HIN/LIN | no | none | COM | 180/220 |
| 21814 | | | | V_{SS}/COM | |
| 2183 | HIN/LIN | yes | Internal 400 | COM | 180/220 |
| 21834 | | | Program 400-5000 | V_{SS}/COM | |
| 2184 | IN/SD | yes | Internal 400 | COM | 680/270 |
| 21844 | | | Program 400-5000 | V_{SS}/COM | |

Typical Connection



Absolute Maximum Ratings

Absolute maximum ratings indicate sustained limits beyond which damage to the device may occur. All voltage parameters are absolute voltages referenced to COM. The thermal resistance and power dissipation ratings are measured under board mounted and still air conditions.

| Symbol | Definition | Min. | Max. | Units | |
|------------|--|----------------|----------------|------------------|--------------------|
| V_B | High-side floating absolute voltage | -0.3 | 620 (Note 1) | V | |
| V_S | High-side floating supply offset voltage | $V_B - 20$ | $V_B + 0.3$ | | |
| V_{HO} | High-side floating output voltage | $V_S - 0.3$ | $V_B + 0.3$ | | |
| V_{CC} | Low-side and logic fixed supply voltage | -0.3 | 20 (Note 1) | | |
| V_{LO} | Low-side output voltage | -0.3 | $V_{CC} + 0.3$ | | |
| V_{IN} | Logic input voltage (HIN & LIN) | $V_{SS} - 0.3$ | $V_{CC} + 0.3$ | | |
| V_{SS} | Logic ground (IRS21814 only) | $V_{CC} - 20$ | $V_{CC} + 0.3$ | | |
| dV_S/dt | Allowable offset supply voltage transient | — | 50 | V/ns | |
| P_D | Package power dissipation @ $T_A \leq +25\text{ }^\circ\text{C}$ | (8-lead PDIP) | — | 1.0 | W |
| | | (8-lead SOIC) | — | 0.625 | |
| | | (14-lead PDIP) | — | 1.6 | |
| | | (14-lead SOIC) | — | 1.0 | |
| R_{thJA} | Thermal resistance, junction to ambient | (8-lead PDIP) | — | 125 | $^\circ\text{C/W}$ |
| | | (8-lead SOIC) | — | 200 | |
| | | (14-lead PDIP) | — | 75 | |
| | | (14-lead SOIC) | — | 120 | |
| T_J | Junction temperature | — | 150 | $^\circ\text{C}$ | |
| T_S | Storage temperature | -50 | 150 | | |
| T_L | Lead temperature (soldering, 10 seconds) | — | 300 | | |

Note 1: All supplies are fully tested at 25 V and an internal 20 V clamp exists for each supply.

Recommended Operating Conditions

The input/output logic timing diagram is shown in Fig. 1. For proper operation the device should be used within the recommended conditions. The V_S and V_{SS} offset rating are tested with all supplies biased at a 15 V differential.

| Symbol | Definition | Min. | Max. | Units |
|----------|--|------------|------------|------------------|
| V_B | High-side floating supply absolute voltage | $V_S + 10$ | $V_S + 20$ | V |
| V_S | High-side floating supply offset voltage | Note 2 | 600 | |
| V_{HO} | High-side floating output voltage | V_S | V_B | |
| V_{CC} | Low-side and logic fixed supply voltage | 10 | 20 | |
| V_{LO} | Low-side output voltage | 0 | V_{CC} | |
| V_{IN} | Logic input voltage (HIN & LIN) | V_{SS} | V_{CC} | |
| V_{SS} | Logic ground (IRS21814 only) | -5 | 5 | |
| T_A | Ambient temperature | -40 | 125 | $^\circ\text{C}$ |

Note 2: Logic operational for V_S of -5 V to +600 V. Logic state held for V_S of -5 V to $-V_{BS}$. (Please refer to the Design Tip DT97-3 for more details).

Dynamic Electrical Characteristics

V_{BIAS} (V_{CC} , V_{BS}) = 15 V, V_{SS} = COM, C_L = 1000 pF, T_A = 25 °C.

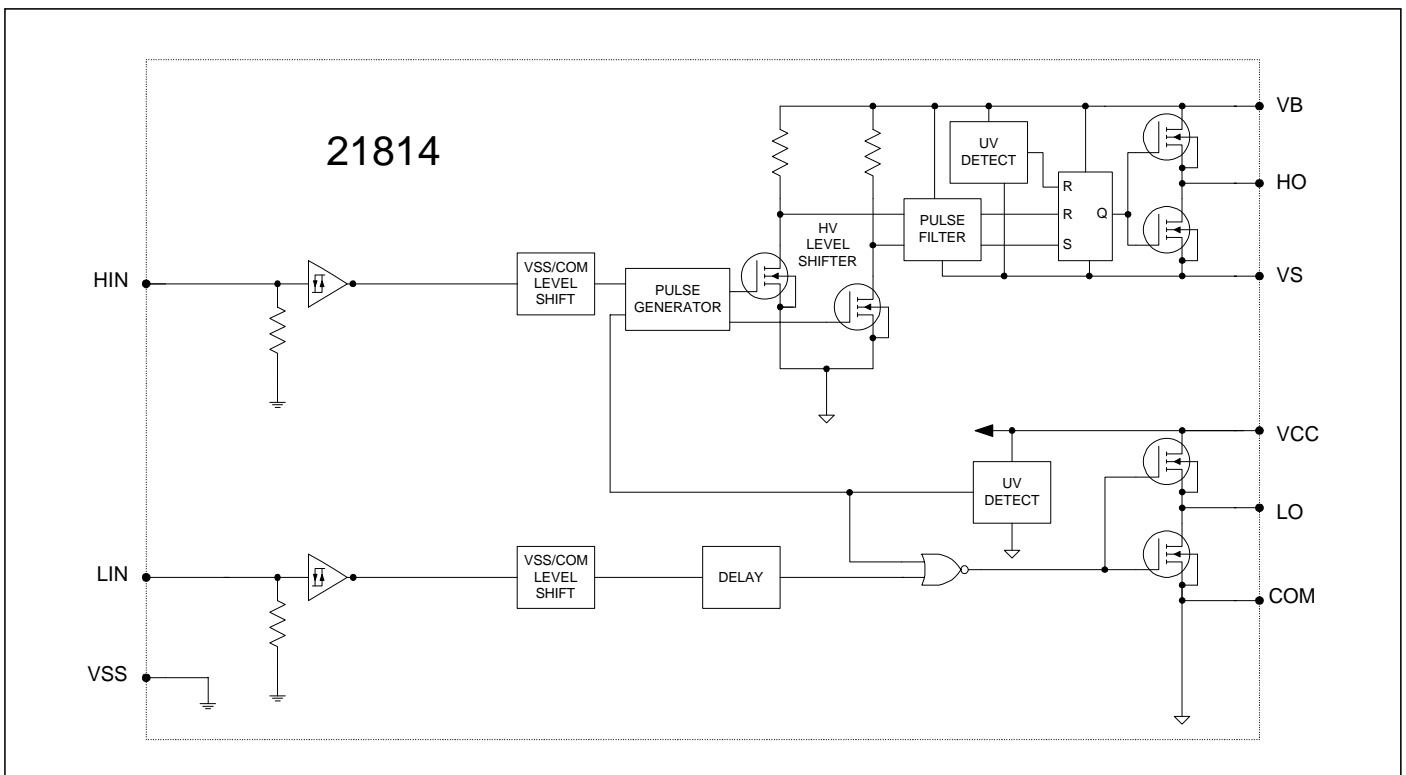
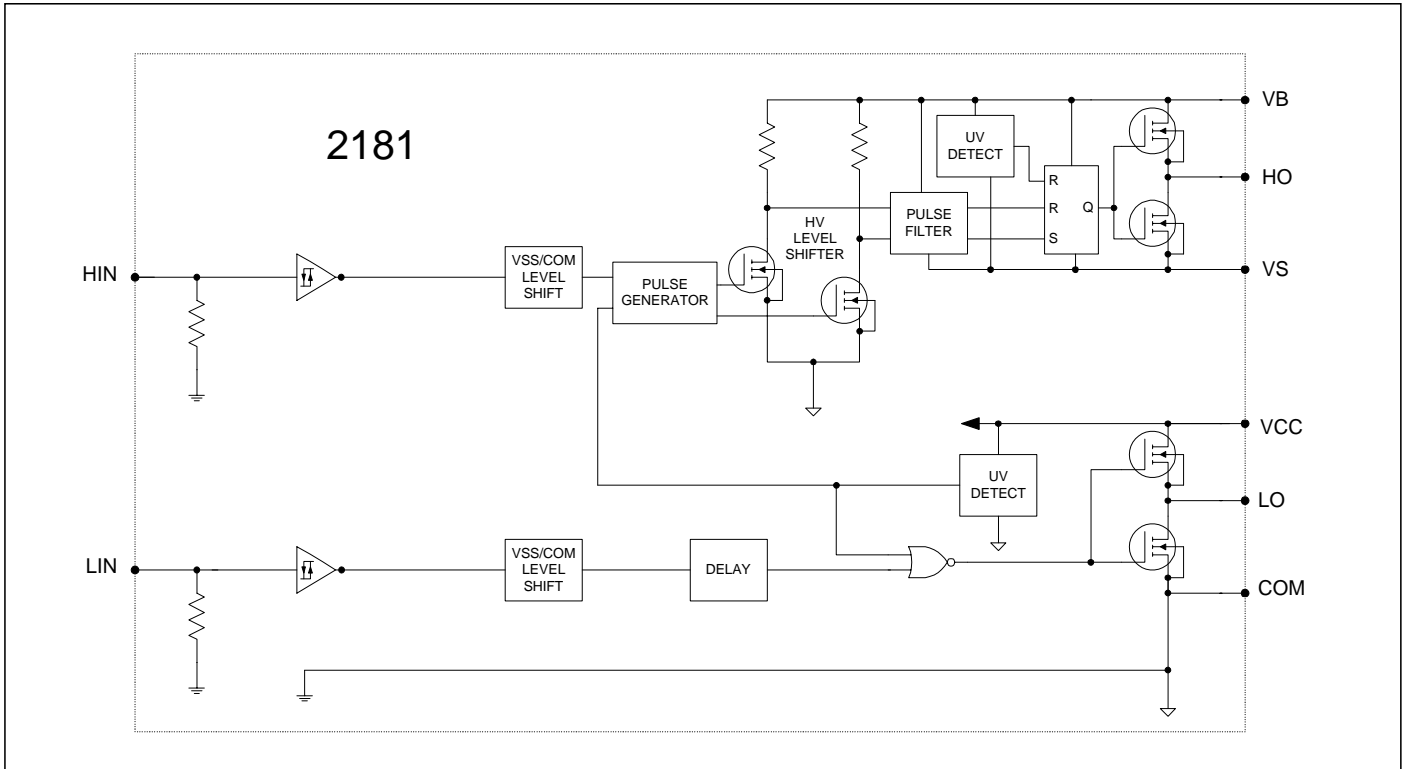
| Symbol | Definition | Min. | Typ. | Max. | Units | Test Conditions |
|-----------|-------------------------------------|------|------|------|-------|----------------------|
| t_{on} | Turn-on propagation delay | — | 180 | 270 | ns | $V_S = 0$ V |
| t_{off} | Turn-off propagation delay | — | 220 | 330 | | $V_S = 0$ V or 600 V |
| MT | Delay matching, HS & LS turn-on/off | — | 0 | 35 | | |
| t_r | Turn-on rise time | — | 40 | 60 | | $V_S = 0$ V |
| t_f | Turn-off fall time | — | 20 | 35 | | |

Static Electrical Characteristics

V_{BIAS} (V_{CC} , V_{BS}) = 15 V, V_{SS} = COM and T_A = 25 °C unless otherwise specified. The V_{IL} , V_{IH} , and I_{IN} parameters are referenced to V_{SS}/COM and are applicable to the respective input leads HIN and LIN. The V_O , I_O , and R_{ON} parameters are referenced to COM and are applicable to the respective output leads: HO and LO.

| Symbol | Definition | Min. | Typ. | Max. | Units | Test Conditions |
|----------------------------|--|------|------|------|---------|---------------------------------------|
| V_{IH} | Logic "1" input voltage | 2.5 | — | — | V | $V_{CC} = 10$ V to 20 V |
| V_{IL} | Logic "0" input voltage | — | — | 0.8 | | $I_O = 0$ A |
| V_{OH} | High level output voltage, $V_{BIAS} - V_O$ | — | — | 1.4 | | $I_O = 20$ mA |
| V_{OL} | Low level output voltage, V_O | — | — | 0.2 | | |
| I_{LK} | Offset supply leakage current | — | — | 50 | μ A | $V_B = V_S = 600$ V |
| I_{QBS} | Quiescent V_{BS} supply current | 20 | 60 | 150 | | $V_{IN} = 0$ V or 5 V |
| I_{QCC} | Quiescent V_{CC} supply current | 50 | 120 | 240 | | $V_{IN} = 5$ V |
| I_{IN+} | Logic "1" input bias current | — | 25 | 60 | | $V_{IN} = 0$ V |
| I_{IN-} | Logic "0" input bias current | — | — | 5.0 | | |
| V_{CCUV+} V_{BSUV+} | V_{CC} and V_{BS} supply undervoltage positive going threshold | 8.0 | 8.9 | 9.8 | V | |
| V_{CCUV-} V_{BSUV-} | V_{CC} and V_{BS} supply undervoltage negative going threshold | 7.4 | 8.2 | 9.0 | | |
| V_{CCUVH} V_{BSUVH} | Hysteresis | 0.3 | 0.7 | — | | |
| I_{O+} | Output high short circuit pulsed current | 1.4 | 1.9 | — | A | $V_O = 0$ V, $PW \leq 10$ μ s |
| I_{O-} | Output low short circuit pulsed current | 1.8 | 2.3 | — | | $V_O = 15$ V, $PW \leq 10$ μ s |

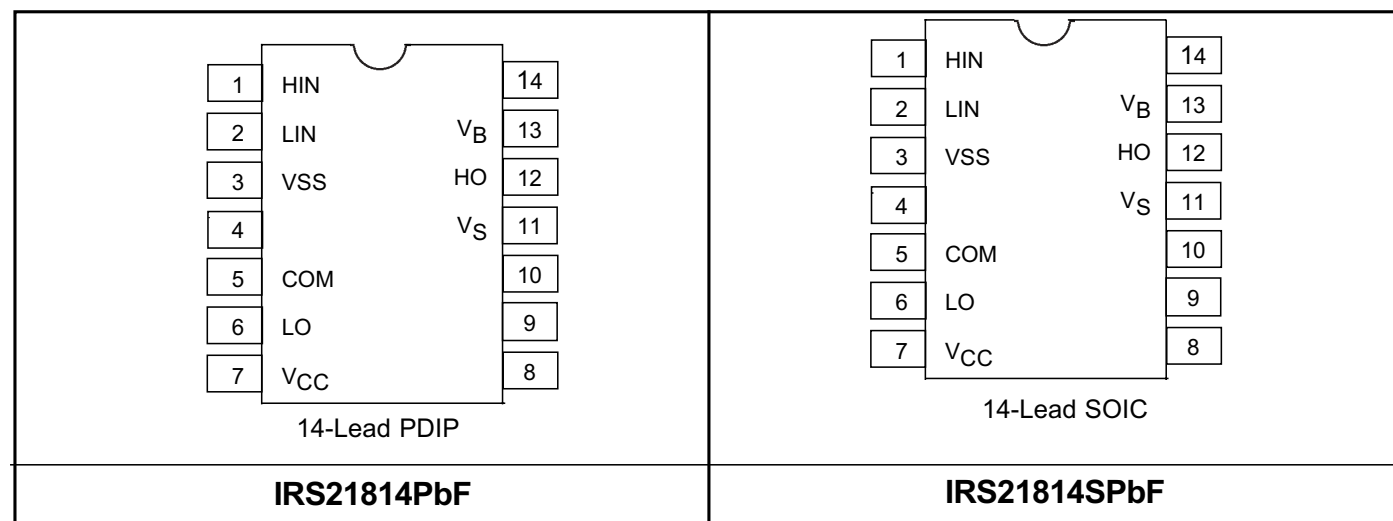
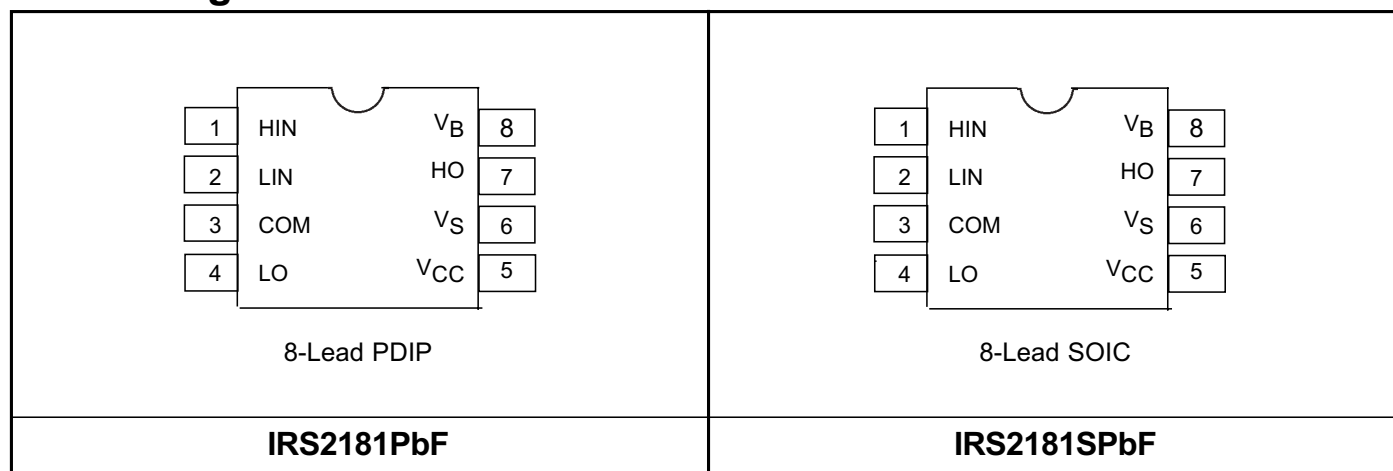
Functional Block Diagrams



Lead Definitions

| Symbol | Description |
|-----------------|--|
| HIN | Logic input for high-side gate driver output (HO), in phase (IRS2181/IRS21814) |
| LIN | Logic input for low-side gate driver output (LO), in phase (IRS2181/IRS21814) |
| VSS | Logic ground (IRS21814 only) |
| V _B | High-side floating supply |
| HO | High-side gate drive output |
| V _S | High-side floating supply return |
| V _{CC} | Low-side and logic fixed supply |
| LO | Low-side gate drive output |
| COM | Low-side return |

Lead Assignments



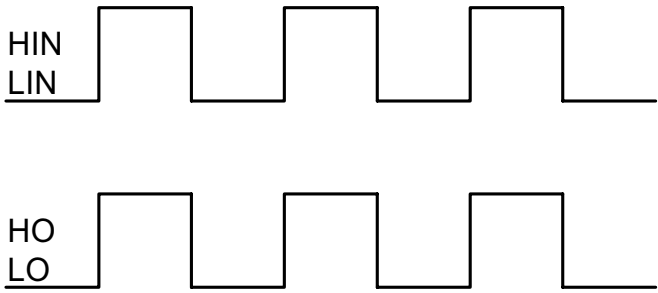


Figure 1. Input/Output Timing Diagram

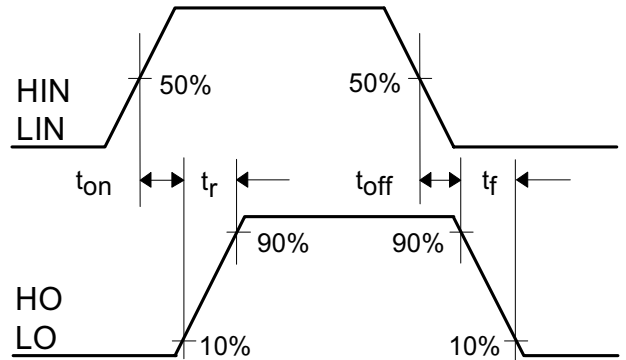


Figure 2. Switching Time Waveform Definitions

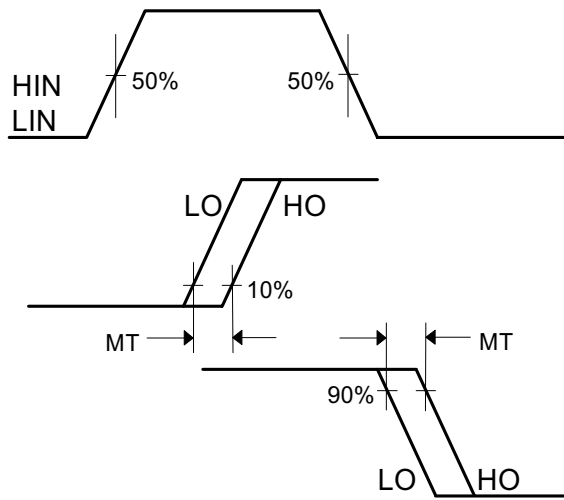


Figure 3. Delay Matching Waveform Definitions

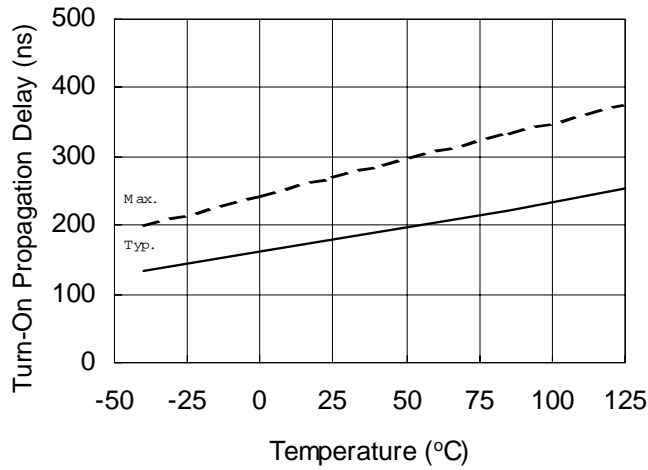


Figure 4A. Turn-On Propagation Delay vs. Temperature

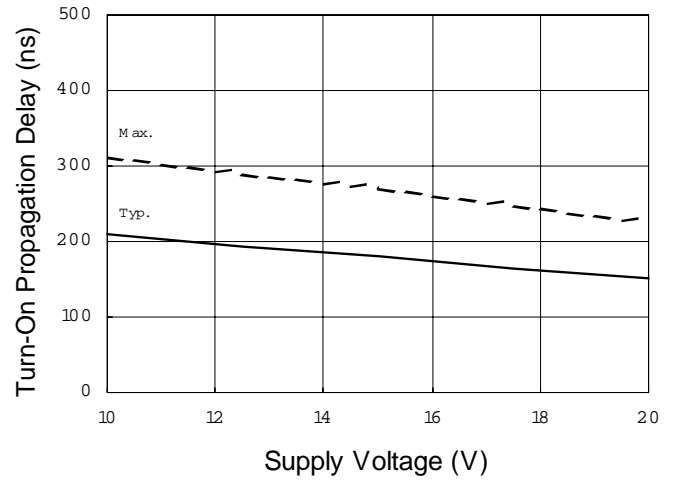


Figure 4B. Turn-On Propagation Delay vs. Supply Voltage

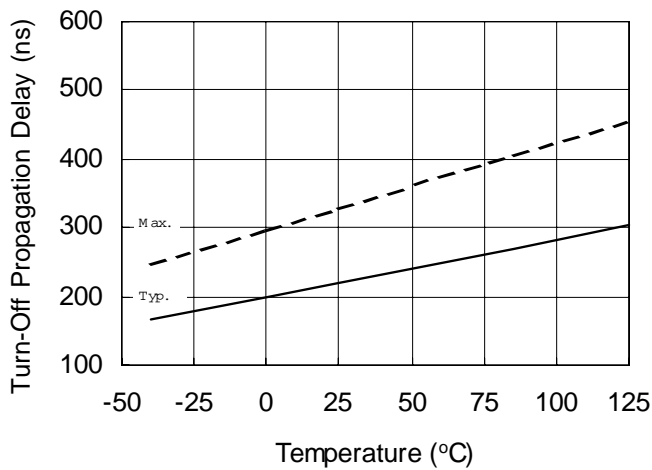


Figure 5A. Turn-Off Propagation Delay vs. Temperature

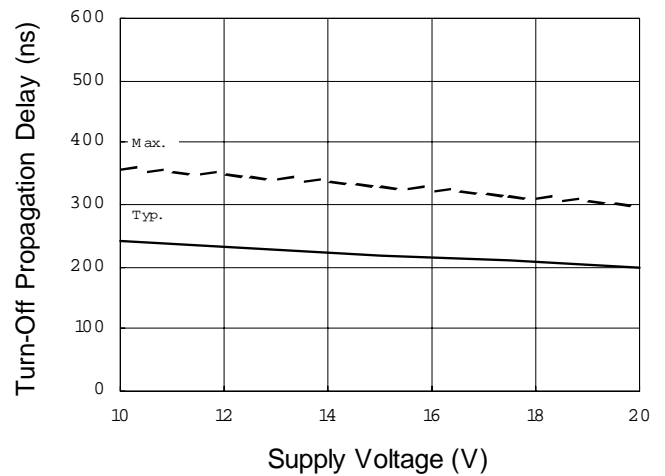


Figure 5B. Turn-Off Propagation Delay vs. Supply Voltage

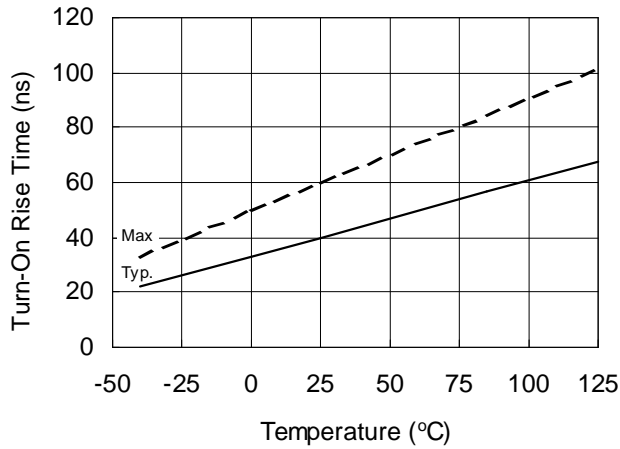


Figure 6A. Turn-On Rise Time vs. Temperature

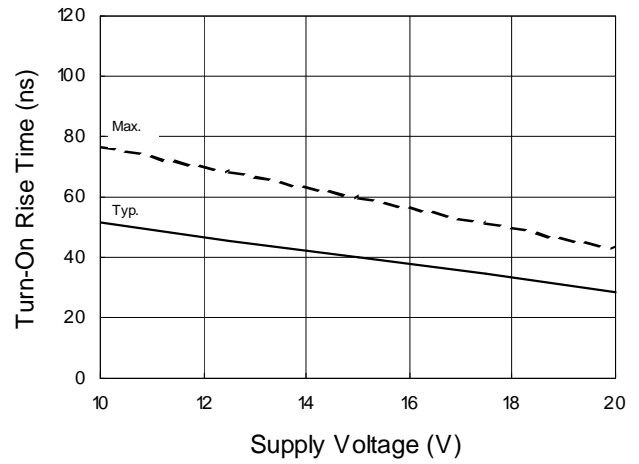


Figure 6B. Turn-On Rise Time vs. Supply Voltage

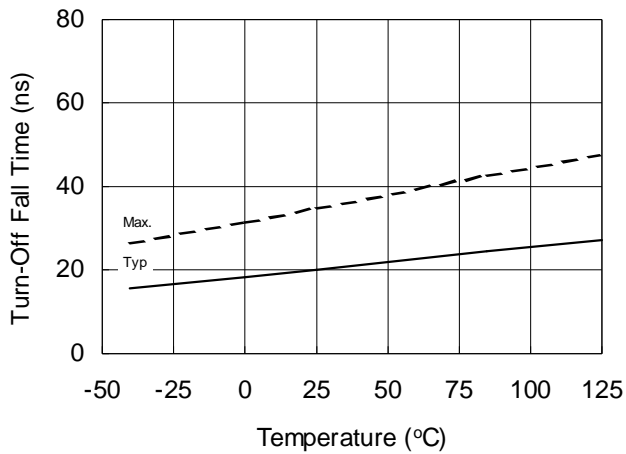


Figure 7A. Turn-Off Fall Time vs. Temperature

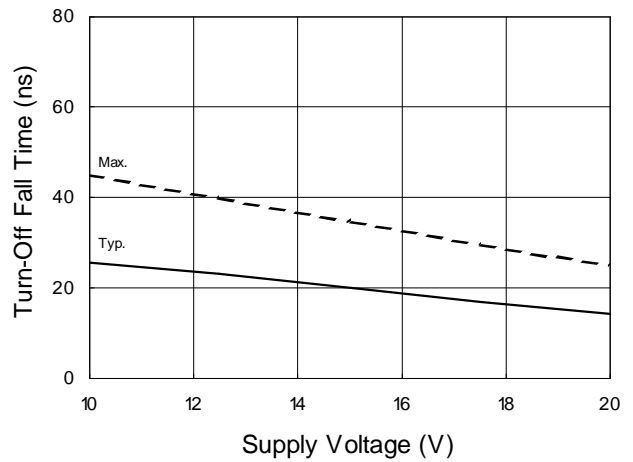


Figure 7B. Turn-Off Fall Time vs. Supply Voltage

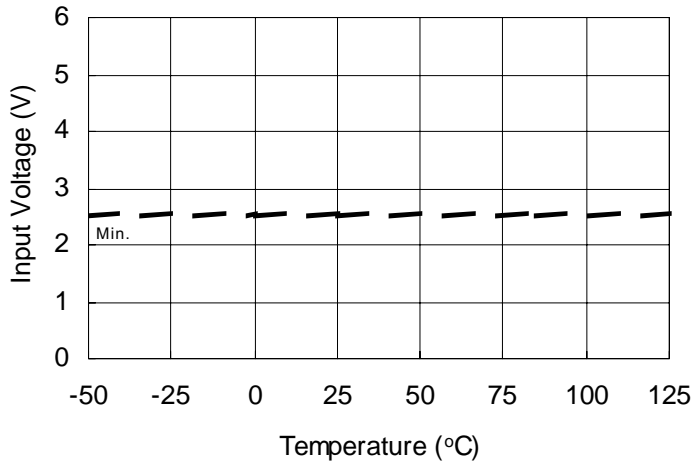


Figure 8A. Logic "1" Input Voltage vs. Temperature

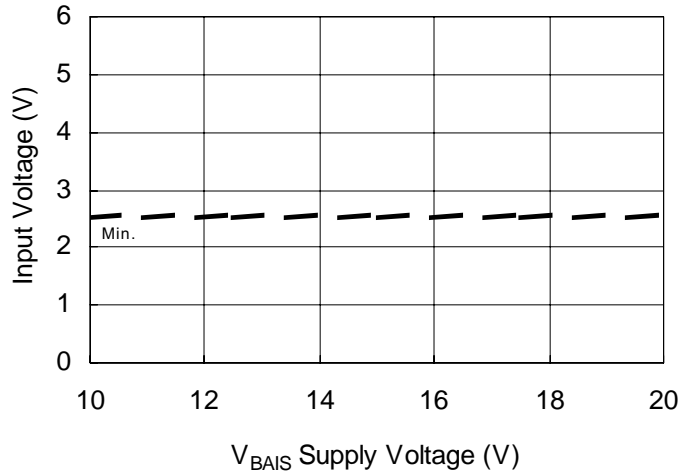


Figure 8B. Logic "1" Input Voltage vs. Supply Voltage

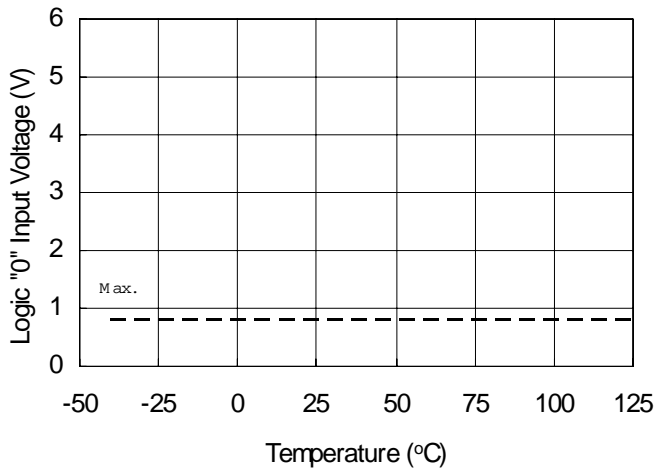


Figure 9A. Logic "0" Input Voltage vs. Temperature

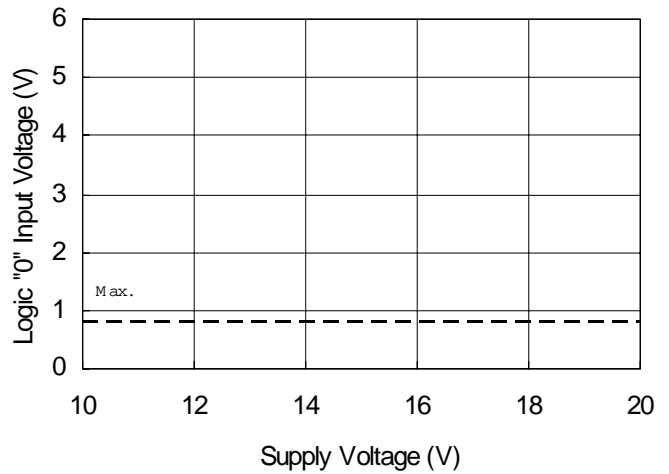


Figure 9B. Logic "0" Input Voltage vs. Supply Voltage

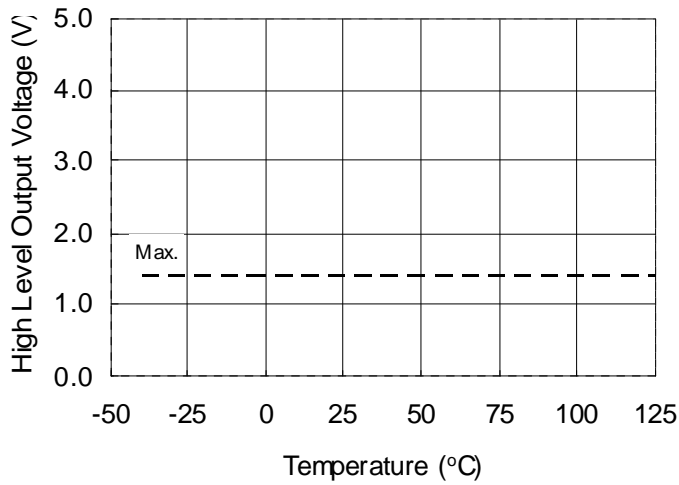


Figure 10A. High Level Output Voltage vs. Temperature ($I_O = 0$ mA)

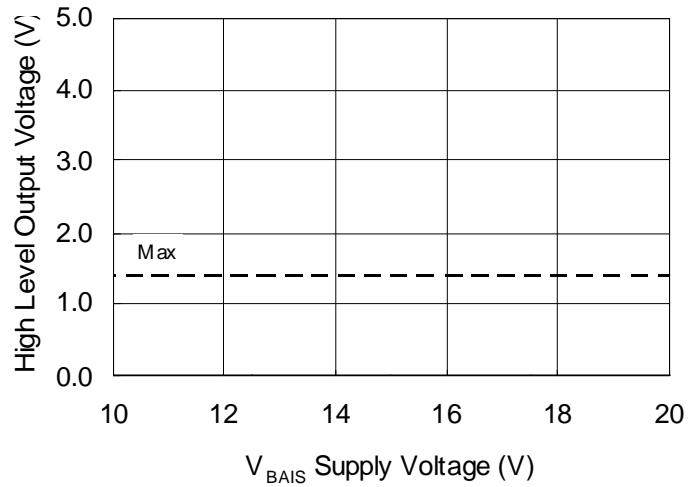


Figure 10B. High Level Output Voltage vs. Supply Voltage ($I_O = 0$ mA)

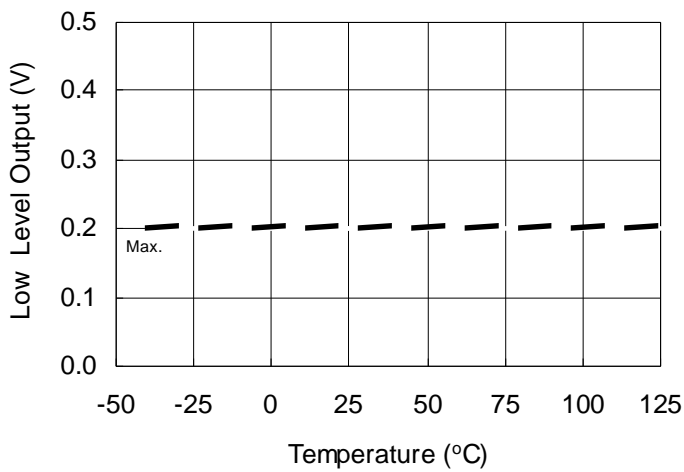


Figure 11A. Low Level Output vs. Temperature

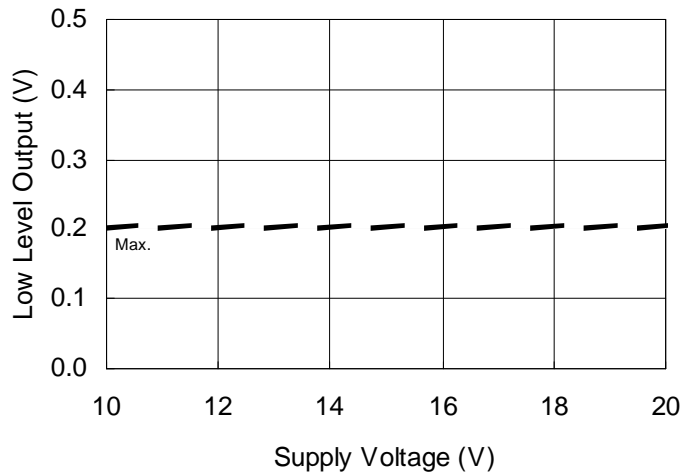


Figure 11B. Low Level Output vs. Supply Voltage

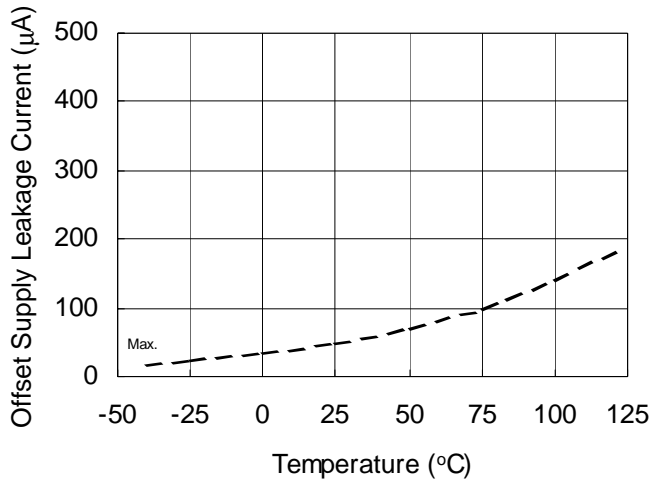


Figure 12A. Offset Supply Leakage Current vs. Temperature

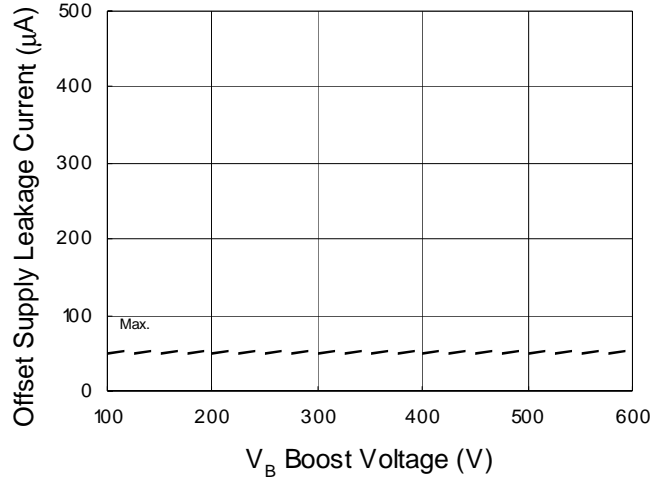


Figure 12B. Offset Supply Leakage Current vs. V_B Boost Voltage

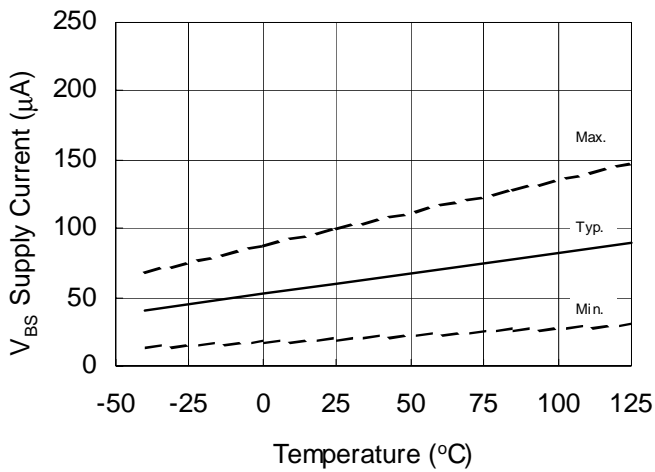


Figure 13A. V_{BS} Supply Current vs. Temperature

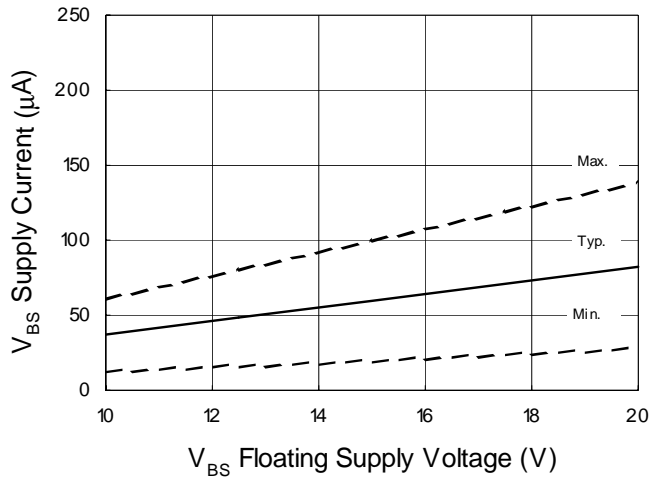


Figure 13B. V_{BS} Supply Current vs. V_{BS} Floating Supply Voltage

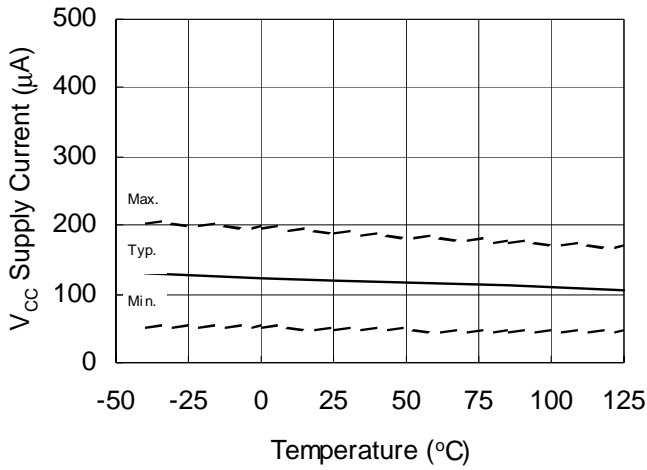


Figure 14A. V_{CC} Supply Current vs. V_{CC} Temperature

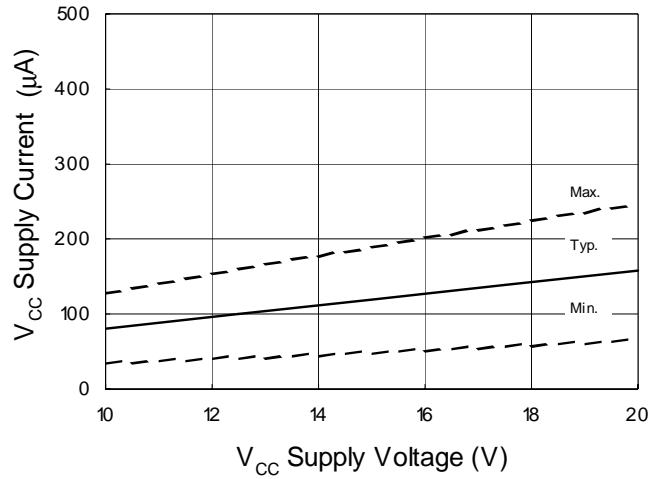


Figure 14B. V_{CC} Supply Current vs. V_{CC} Supply Voltage

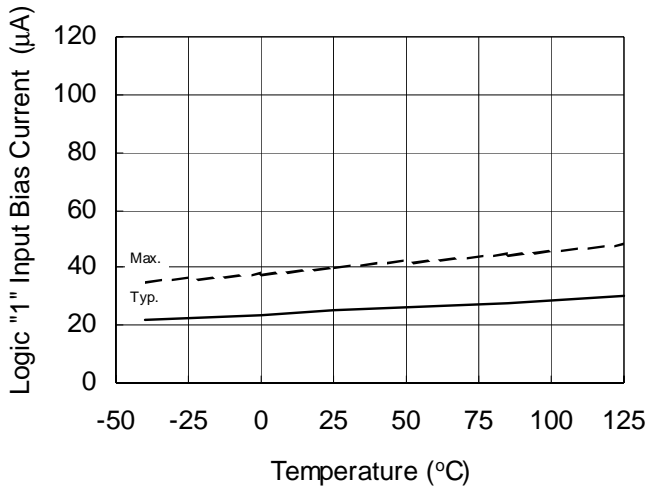


Figure 15A. Logic "1" Input Bias Current vs. Temperature

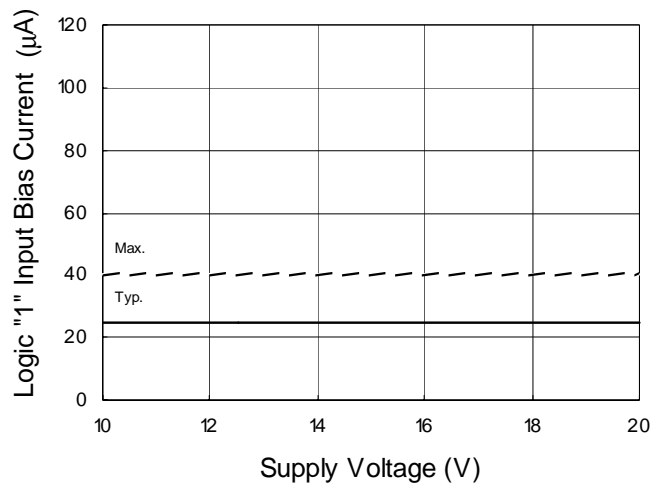


Figure 15B. Logic "1" Input Bias Current vs. Supply Voltage

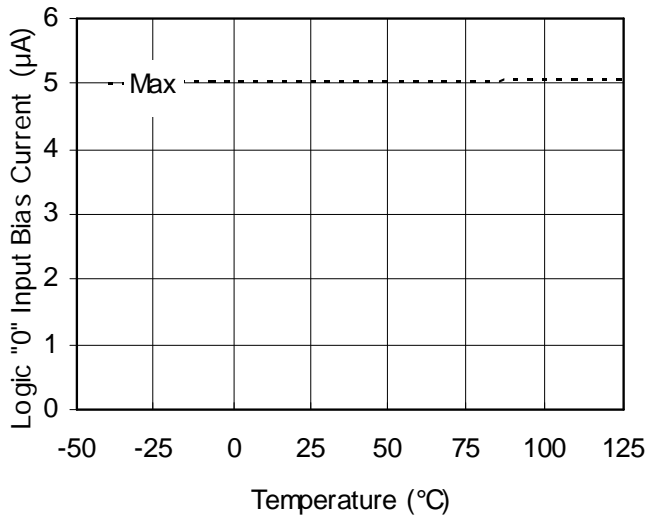


Figure 16A. Logic "0" Input Bias Current vs. Temperature

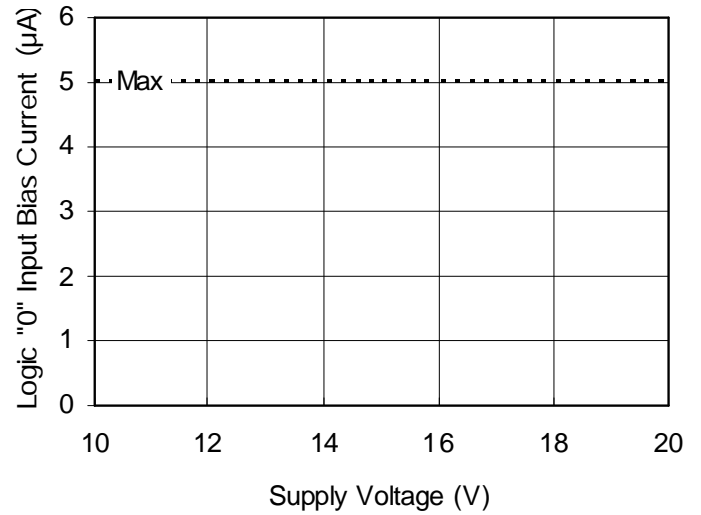


Figure 16B. Logic "0" Input Bias Current vs. Voltage

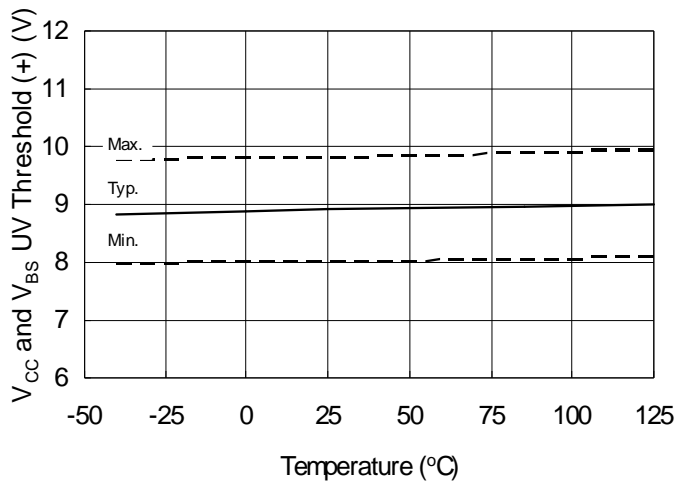


Figure 17. V_{CC} and V_{BS} Undervoltage Threshold (+) vs. Temperature

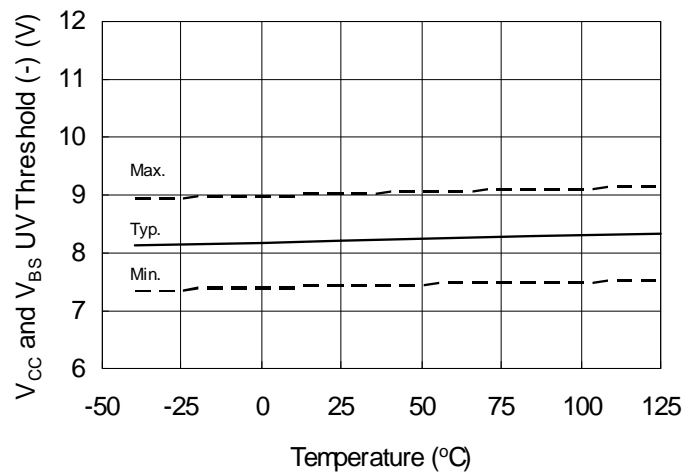


Figure 18. V_{CC} and V_{BS} Undervoltage Threshold (-) vs. Temperature

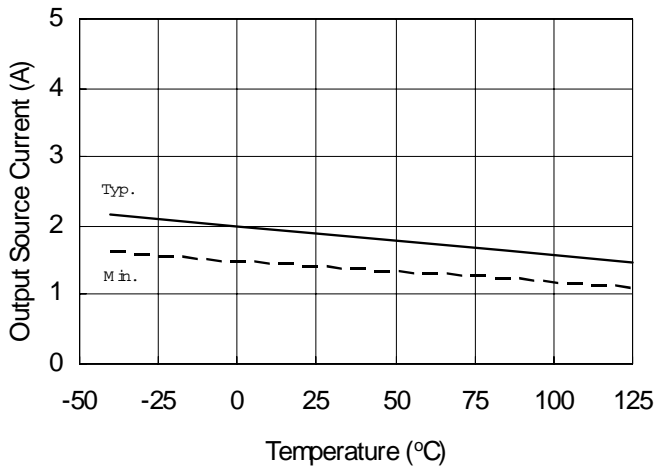


Figure 19A. Output Source Current vs. Temperature

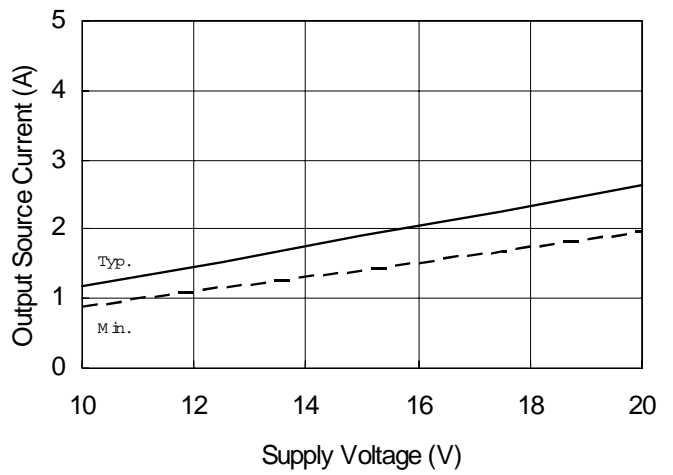


Figure 19B. Output Source Current vs. Supply Voltage

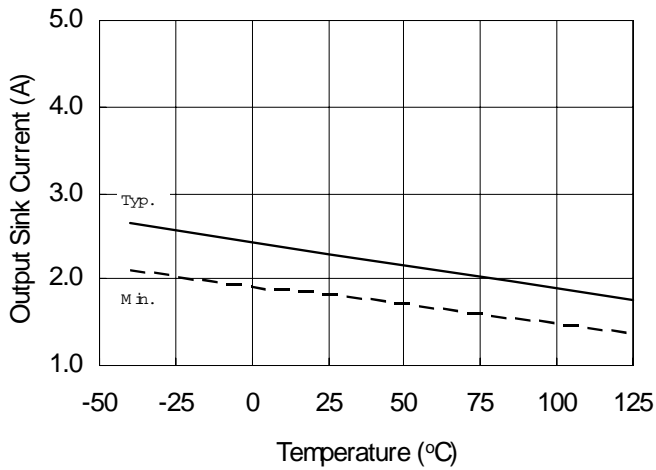


Figure 20A. Output Sink Current vs. Temperature

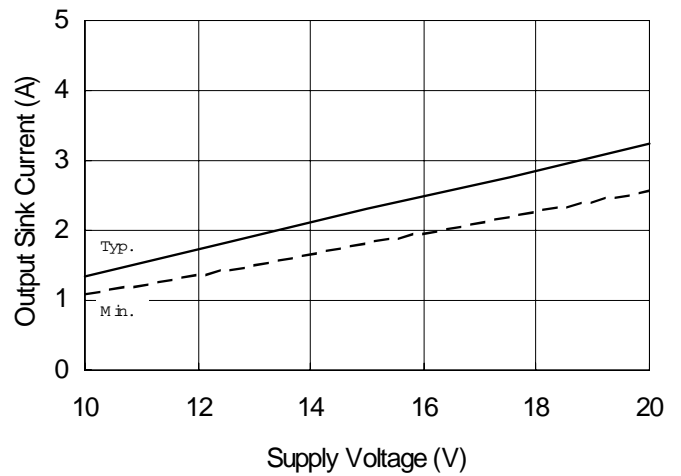
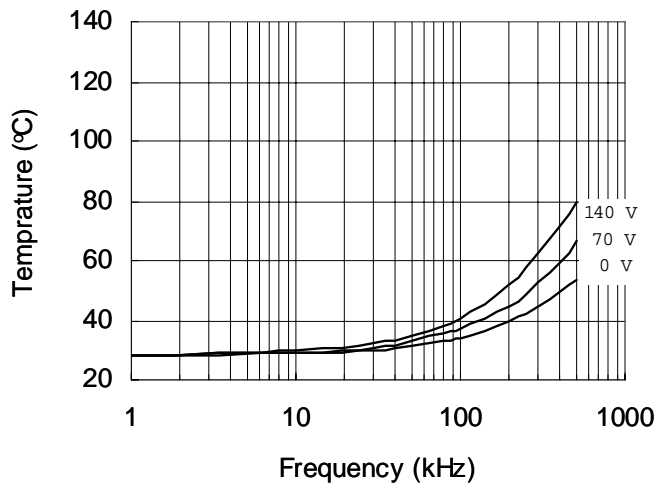
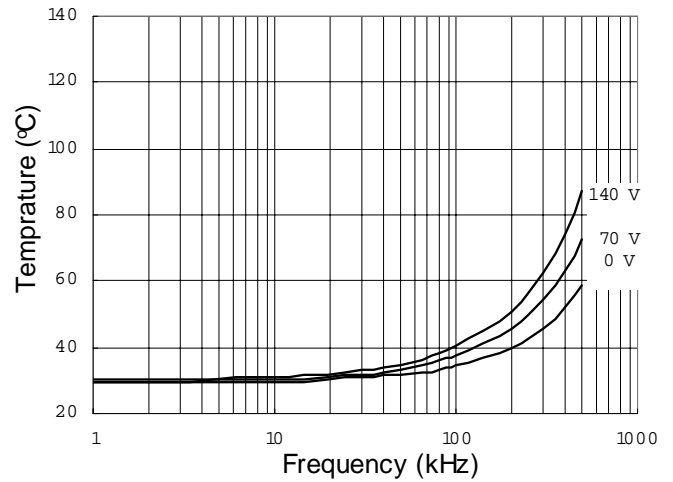


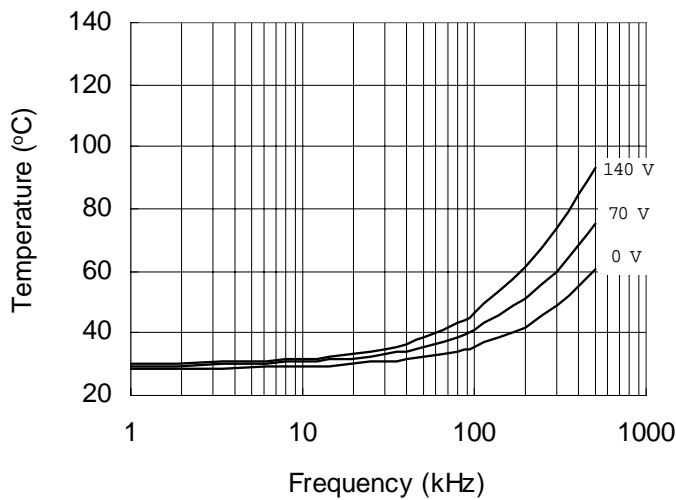
Figure 20B. Output Sink Current vs. Supply Voltage



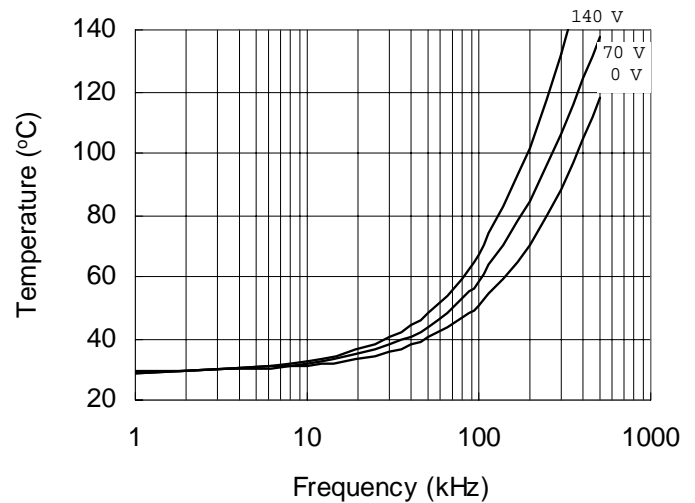
**Figure 21. IRS2181 vs. Frequency (IRFBC20),
 $R_{gate}=33 \Omega$, $V_{CC}=15 V$**



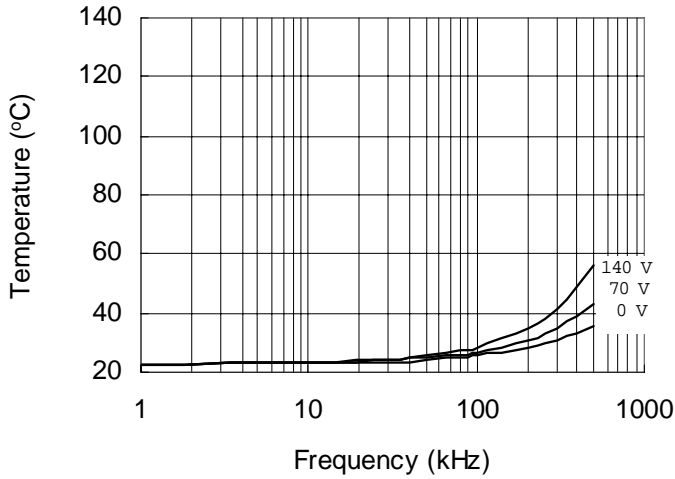
**Figure 22. IRS2181 vs. Frequency (IRFBC30),
 $R_{gate}=22 \Omega$, $V_{CC}=15 V$**



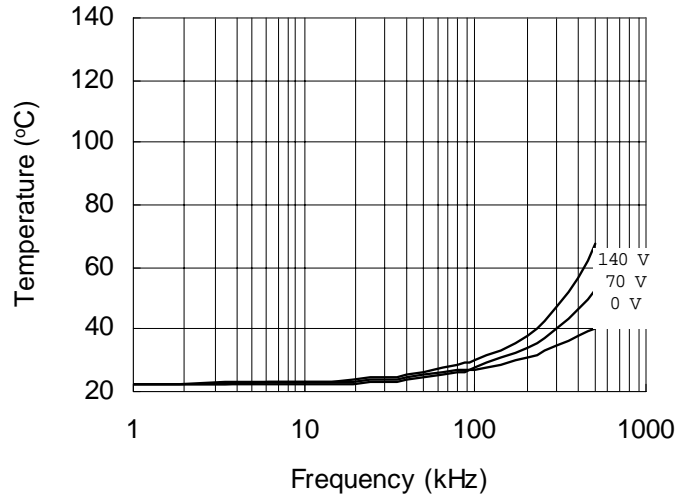
**Figure 23. IRS2181 vs. Frequency (IRFBC40),
 $R_{gate}=15 \Omega$, $V_{CC}=15 V$**



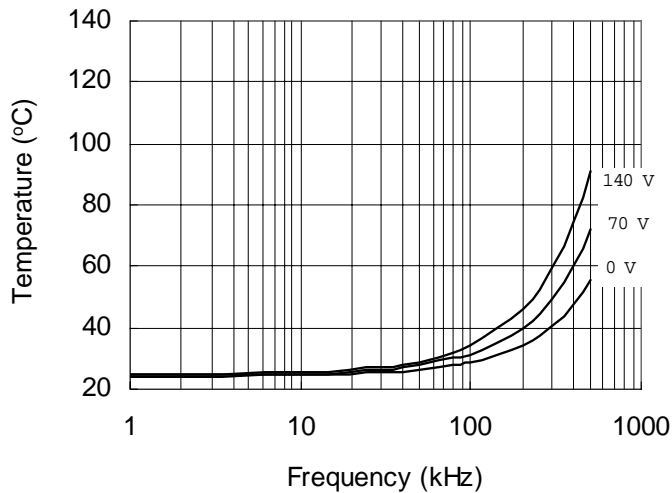
**Figure 24. IRS2181 vs. Frequency (IRFPE50),
 $R_{gate}=10 \Omega$, $V_{CC}=15 V$**



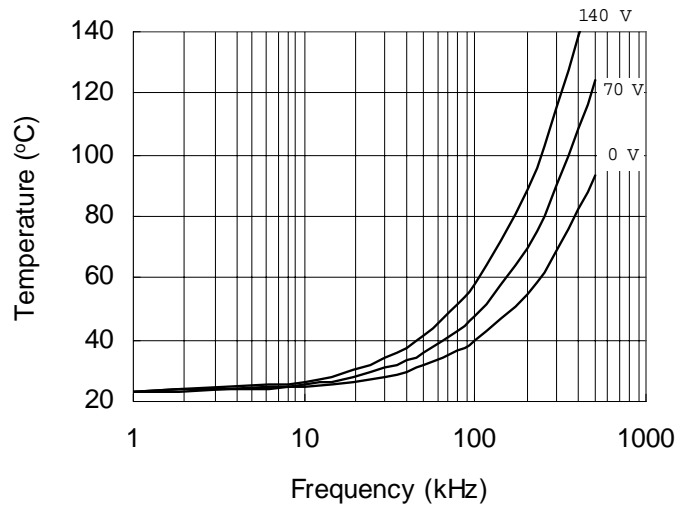
**Figure 25. IRS21814 vs. Frequency (IRFBC20),
 $R_{gate}=33 \Omega$, $V_{CC}=15 V$**



**Figure 26. IRS21814 vs. Frequency (IRFBC30),
 $R_{gate}=22 \Omega$, $V_{CC}=15 V$**



**Figure 27. IRS21814 vs. Frequency (IRFBC40),
 $R_{gate}=15 \Omega$, $V_{CC}=15 V$**



**Figure 28. IRS21814 vs. Frequency (IRFPE50),
 $R_{gate}=10 \Omega$, $V_{CC}=15 V$**

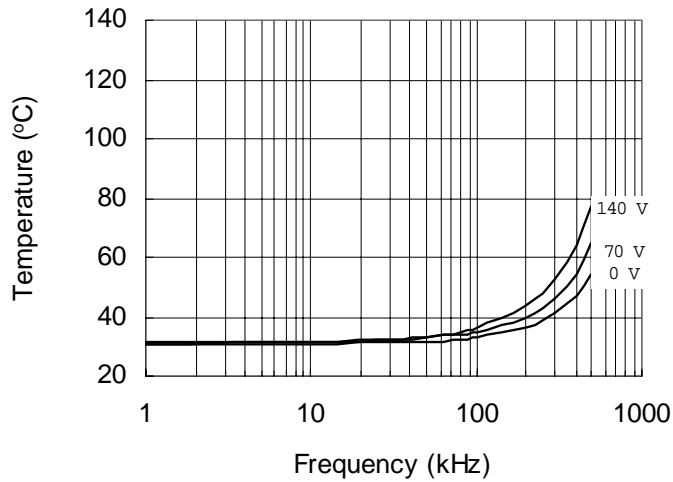


Figure 29. IRS2181S vs. Frequency (IRFBC20),
 $R_{gate}=33 \Omega, V_{CC}=15 V$

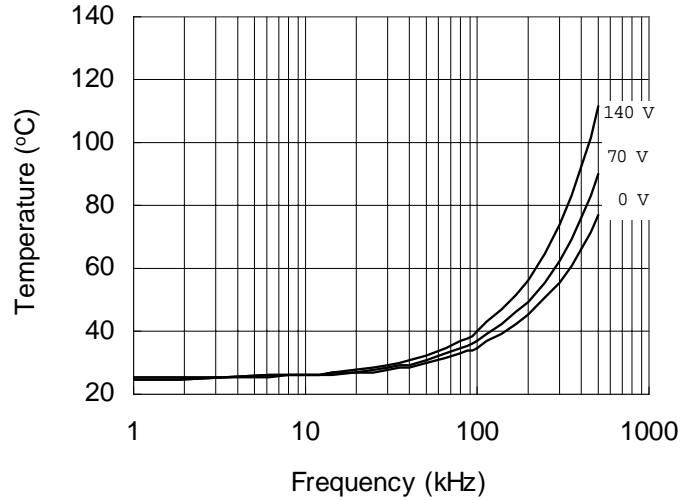


Figure 30. IRS2181S vs. Frequency (IRFBC30),
 $R_{gate}=22 \Omega, V_{CC}=15 V$

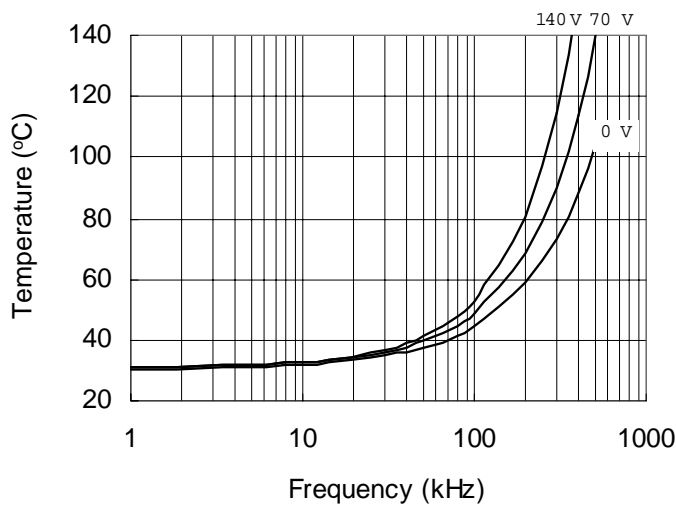


Figure 31. IRS2181S vs. Frequency (IRFBC40),
 $R_{gate}=15 \Omega, V_{CC}=15 V$

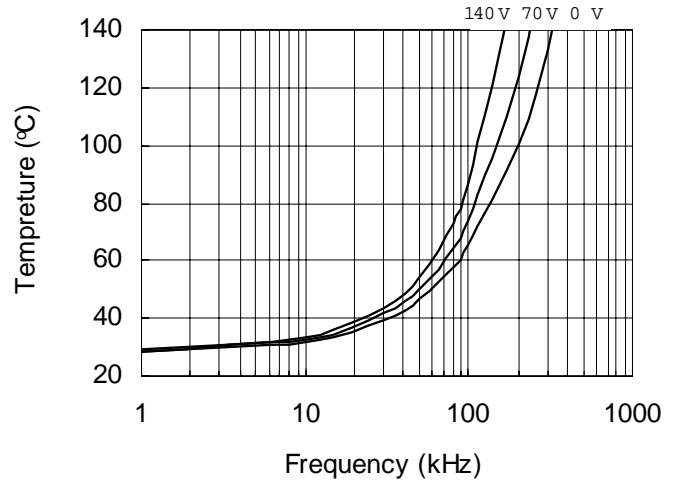
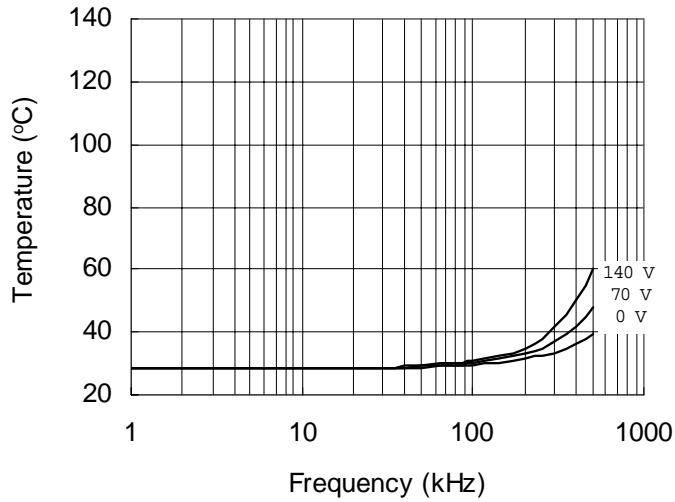
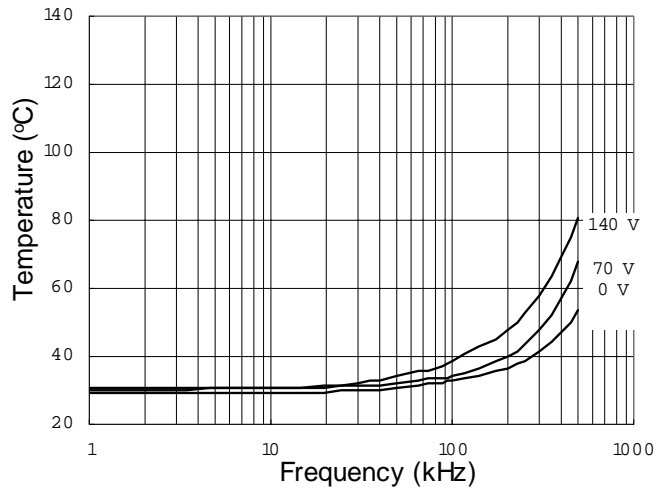


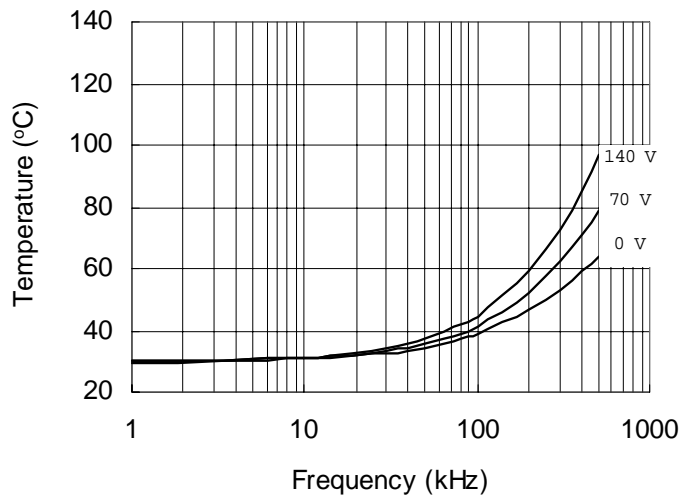
Figure 32. IRS2181S vs. Frequency (IRFPE50),
 $R_{gate}=10 \Omega, V_{CC}=15 V$



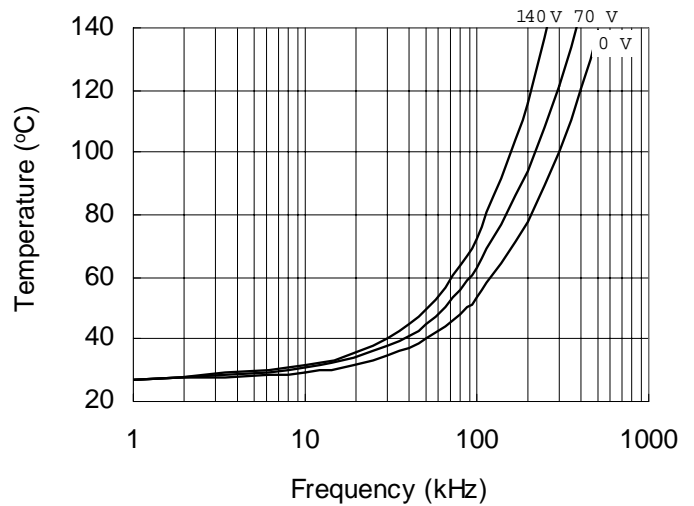
**Figure 33. IRS21814S vs. Frequency (IRFBC20),
 $R_{gate}=33 \Omega, V_{CC}=15 V$**



**Figure 34. IRS21814S vs. Frequency (IRFBC30),
 $R_{gate}=22 \Omega, V_{CC}=15 V$**



**Figure 35. IRS21814S vs. Frequency (IRFBC40),
 $R_{gate}=15 \Omega, V_{CC}=15 V$**



**Figure 36. IRS21814S vs. Frequency (IRFPE50),
 $R_{gate}=10 \Omega, V_{CC}=15 V$**

Case outlines

8-Lead PDIP

01-6014
01-3003 01 (MS-001AB)

NOTES:

1. DIMENSIONING & TOLERANCING PER ANSI Y14.5M-1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSIONS ARE SHOWN IN MILLIMETERS [INCHES].
4. OUTLINE CONFORMS TO JEDEC OUTLINE MS-001AB.
- 5 MEASURED WITH THE LEADS CONSTRAINED TO BE PERPENDICULAR TO DATUM PLANE C.
- 6 DIMENSION DOES NOT INCLUDE MOLD PROTUSIONS. MOLD PROTUSIONS SHALL NOT EXCEED 0.25 [.010].

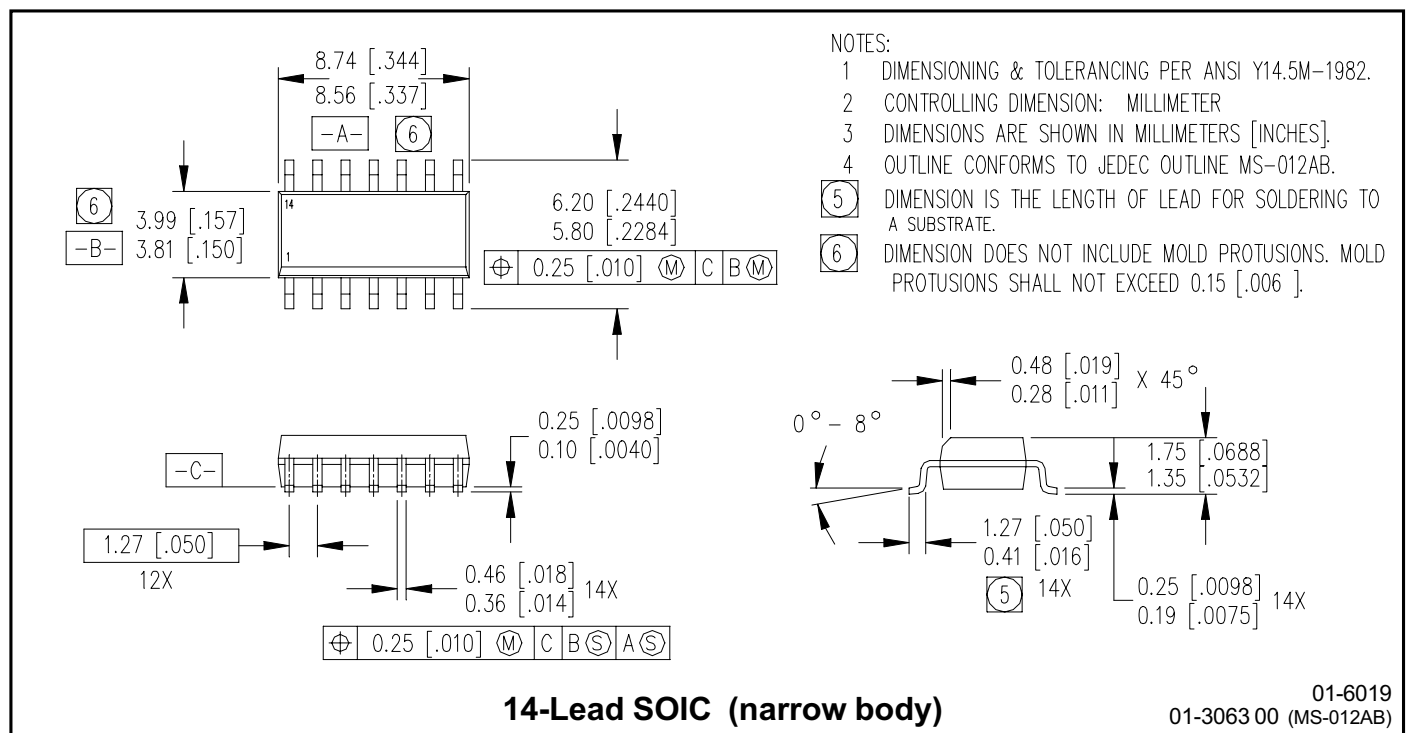
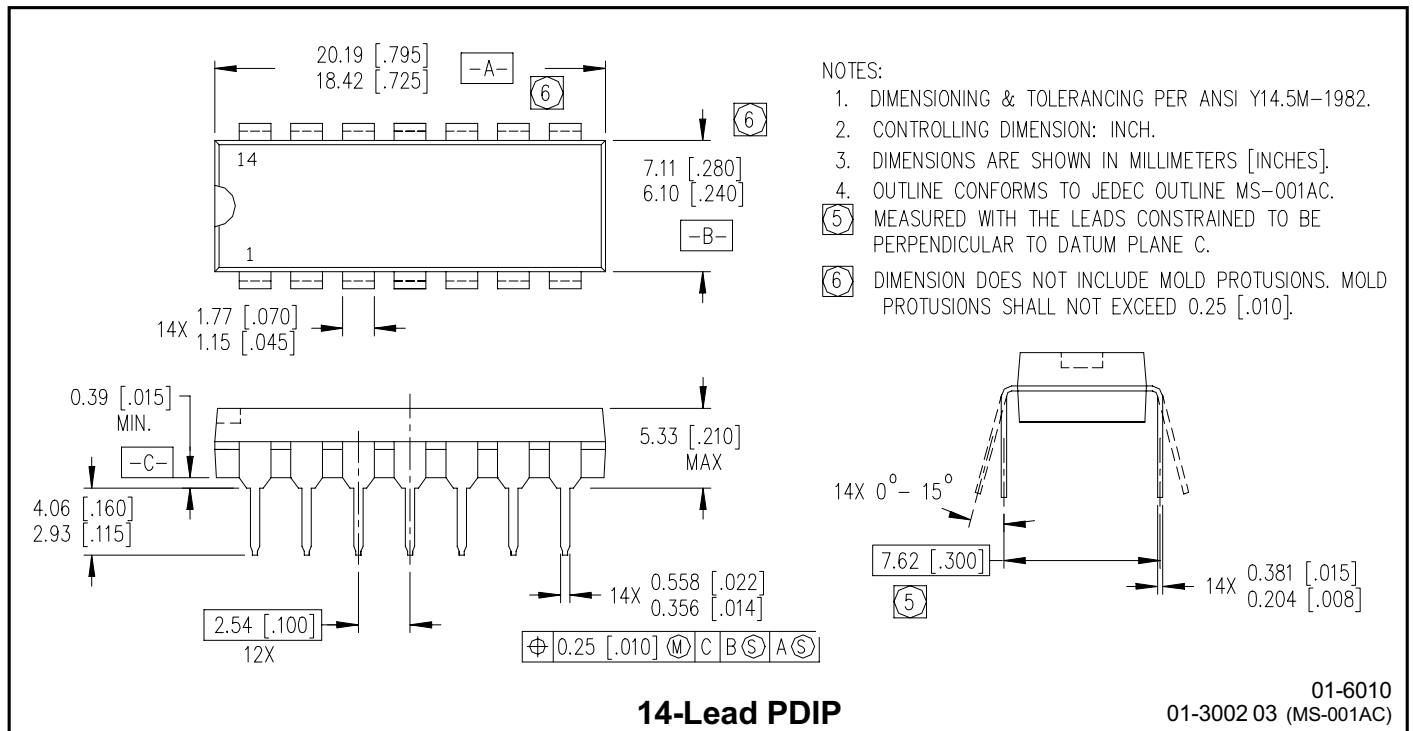
8-Lead SOIC

01-6027
01-0021 11 (MS-012AA)

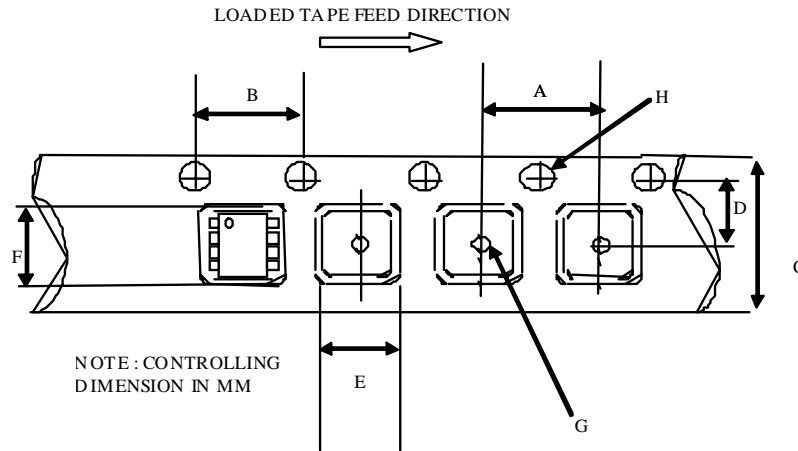
| DIM | INCHES | | MILLIMETERS | |
|-----|------------|-------|-------------|------|
| | MIN | MAX | MIN | MAX |
| A | .0532 | .0688 | 1.35 | 1.75 |
| A1 | .0040 | .0098 | 0.10 | 0.25 |
| b | .013 | .020 | 0.33 | 0.51 |
| c | .0075 | .0098 | 0.19 | 0.25 |
| D | .189 | .1968 | 4.80 | 5.00 |
| E | .1497 | .1574 | 3.80 | 4.00 |
| e | .050 BASIC | | 1.27 BASIC | |
| e 1 | .025 BASIC | | 0.635 BASIC | |
| H | .2284 | .2440 | 5.80 | 6.20 |
| K | .0099 | .0196 | 0.25 | 0.50 |
| L | .016 | .050 | 0.40 | 1.27 |
| y | 0° | 8° | 0° | 8° |

NOTES:

1. DIMENSIONING & TOLERANCING PER ASME Y14.5M-1994.
2. CONTROLLING DIMENSION: MILLIMETER
3. DIMENSIONS ARE SHOWN IN MILLIMETERS [INCHES].
4. OUTLINE CONFORMS TO JEDEC OUTLINE MS-012AA.
- 5 DIMENSION DOES NOT INCLUDE MOLD PROTUSIONS. MOLD PROTUSIONS NOT TO EXCEED 0.15 [.006].
- 6 DIMENSION DOES NOT INCLUDE MOLD PROTUSIONS. MOLD PROTUSIONS NOT TO EXCEED 0.25 [.010].
- 7 DIMENSION IS THE LENGTH OF LEAD FOR SOLDERING TO A SUBSTRATE.

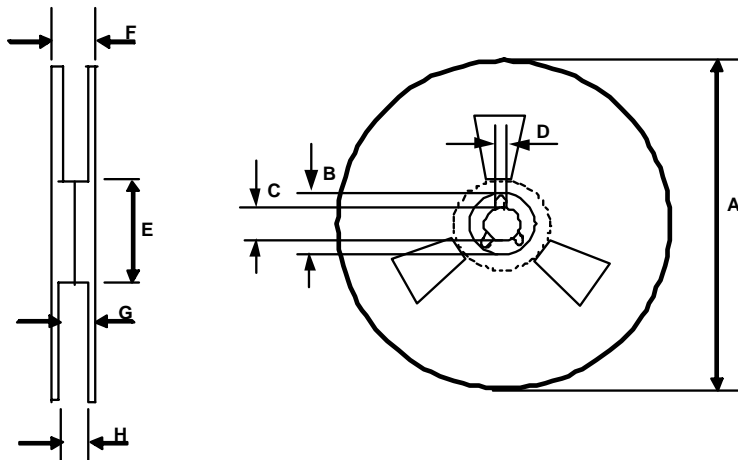


Tape & Reel 8-lead SOIC



CARRIER TAPE DIMENSION FOR 8SOICN

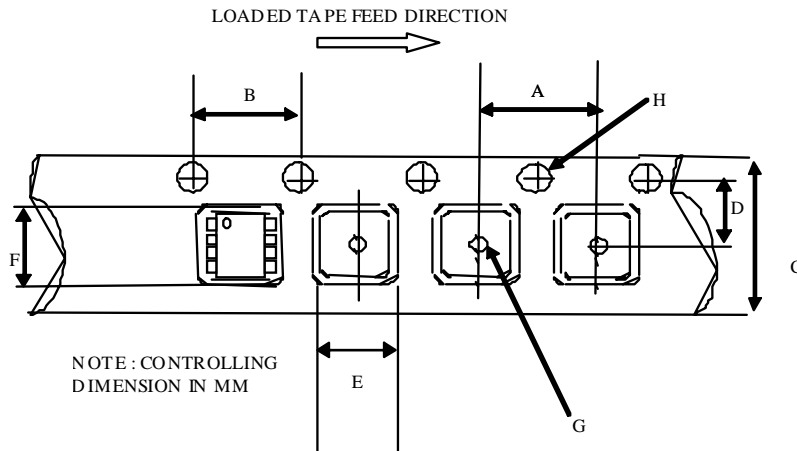
| Code | Metric | | Imperial | |
|------|--------|-------|----------|-------|
| | Min | Max | Min | Max |
| A | 7.90 | 8.10 | 0.311 | 0.318 |
| B | 3.90 | 4.10 | 0.153 | 0.161 |
| C | 11.70 | 12.30 | 0.46 | 0.484 |
| D | 5.45 | 5.55 | 0.214 | 0.218 |
| E | 6.30 | 6.50 | 0.248 | 0.255 |
| F | 5.10 | 5.30 | 0.200 | 0.208 |
| G | 1.50 | n/a | 0.059 | n/a |
| H | 1.50 | 1.60 | 0.059 | 0.062 |



REEL DIMENSIONS FOR 8SOICN

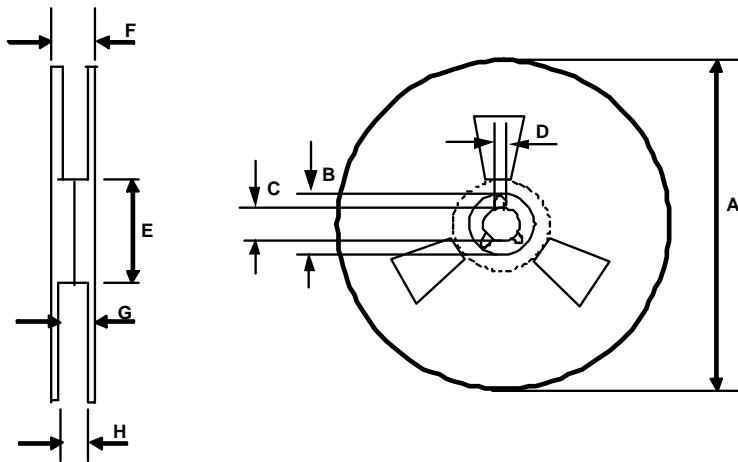
| Code | Metric | | Imperial | |
|------|--------|--------|----------|--------|
| | Min | Max | Min | Max |
| A | 329.60 | 330.25 | 12.976 | 13.001 |
| B | 20.95 | 21.45 | 0.824 | 0.844 |
| C | 12.80 | 13.20 | 0.503 | 0.519 |
| D | 1.95 | 2.45 | 0.767 | 0.096 |
| E | 98.00 | 102.00 | 3.858 | 4.015 |
| F | n/a | 18.40 | n/a | 0.724 |
| G | 14.50 | 17.10 | 0.570 | 0.673 |
| H | 12.40 | 14.40 | 0.488 | 0.566 |

Tape & Reel 14-lead SOIC



CARRIER TAPE DIMENSION FOR 14SOICN

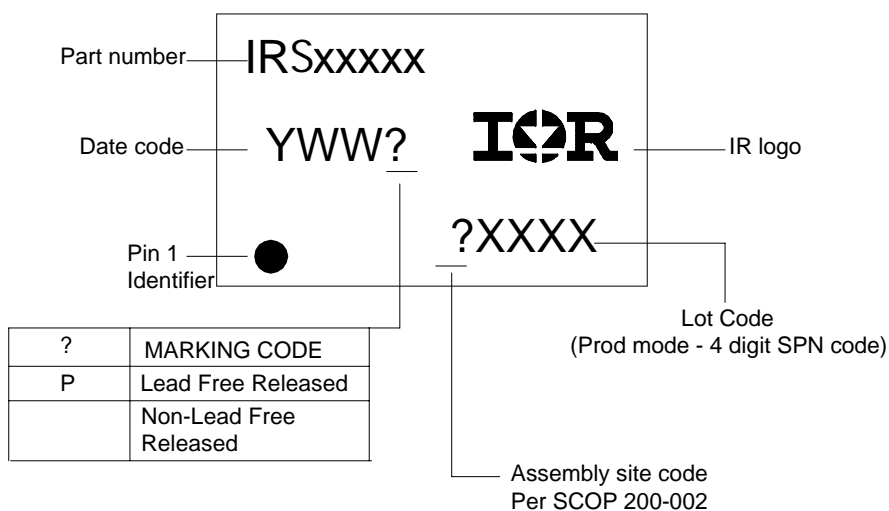
| Code | Metric | | Imperial | |
|------|--------|-------|----------|-------|
| | Min | Max | Min | Max |
| A | 7.90 | 8.10 | 0.311 | 0.318 |
| B | 3.90 | 4.10 | 0.153 | 0.161 |
| C | 15.70 | 16.30 | 0.618 | 0.641 |
| D | 7.40 | 7.60 | 0.291 | 0.299 |
| E | 6.40 | 6.60 | 0.252 | 0.260 |
| F | 9.40 | 9.60 | 0.370 | 0.378 |
| G | 1.50 | n/a | 0.059 | n/a |
| H | 1.50 | 1.60 | 0.059 | 0.062 |



REEL DIMENSIONS FOR 14SOICN

| Code | Metric | | Imperial | |
|------|--------|--------|----------|--------|
| | Min | Max | Min | Max |
| A | 329.60 | 330.25 | 12.976 | 13.001 |
| B | 20.95 | 21.45 | 0.824 | 0.844 |
| C | 12.80 | 13.20 | 0.503 | 0.519 |
| D | 1.95 | 2.45 | 0.767 | 0.096 |
| E | 98.00 | 102.00 | 3.858 | 4.015 |
| F | n/a | 22.40 | n/a | 0.881 |
| G | 18.50 | 21.10 | 0.728 | 0.830 |
| H | 16.40 | 18.40 | 0.645 | 0.724 |

LEADFREE PART MARKING INFORMATION



ORDER INFORMATION

8-Lead PDIP IRS2181PbF
 8-Lead SOIC IRS2181SPbF
 8-Lead SOIC Tape & Reel IRS2181STRPbF

14-Lead PDIP IRS21814PbF
 14-Lead SOIC IRS21814SPbF
 14-Lead SOIC Tape & Reel IRS21814STRPbF